Electronic Patent	App	olication Fee	Transmi	ttal		
Application Number:	09546174					
Filing Date:	11-Apr-2000					
Title of Invention:	HIGH DENSITY PLASMA CHEMICAL VAPOR DEPOSITION PROCESS					
First Named Inventor/Applicant Name:	Chih-Chien Liu					
Filer:	William H. Wright					
Attorney Docket Number:	JIA 462C1					
Filed as Large Entity						
Utility under 35 USC 111(a) Filing Fees						
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Basic Filing:						
Pages:						
Claims:						
Miscellaneous-Filing:						
Petition:						
Patent-Appeals-and-Interference:						
Filing a brief in support of an appeal		1402	1	510	510	
Post-Allowance-and-Post-Issuance:						
Extension-of-Time:						

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Extension - 1 month with \$0 paid	1251	1	120	120	
Miscellaneous:					
	Total in USD (\$)				